

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCI No.	ADG/24/14579
1.3 Title of PCI	Unification of IT Manufacturing Infrastructure for AG200
1.4 Product Category	see list
1.5 Issue date	2024-02-14

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Matteo AMADEO,Lorenzo MOIOLI,Carmelo PISTRITTO,Giovanni Luca TORRISI,Stefano Maria RICCIARDI
2.1.2 Marketing Manager	Alberto CAROLI,Valeria SCARCELLI,Rosario RUGGERI,Salvatore ABBISSO,Matteo AMIGHINI
2.1.3 Quality Manager	Alberto BIGNAZZI,Marcello Donato MENCHISE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General (Logistic)	(Not Defined)	AG200 - Agrate Italy

4. Description of change

	Old	New
4.1 Description	Manufacturing Organization: R2 and AG8-AGM	Manufacturing Organization: AG200
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Rationalization at IT level
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Lot naming described in the Notification
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7. Timing / schedule

7.1 Date of qualification results	2024-01-31
7.2 Intended start of delivery	2024-02-29
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description	14579 AG200_IT_infrastructure_merge.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2024-02-14

9. Attachments (additional documentations)

14579 Public product.pdf
14579 AG200_IT_infrastructure_merge.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L9779WD-SPI-TR	
	L9966CB-TR	

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